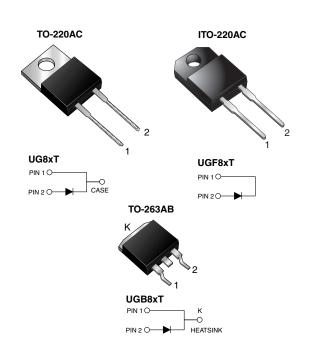


Vishay General Semiconductor

Ultrafast Rectifier

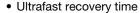


PRIMARY CHARACTERISTICS						
I _{F(AV)}	8.0 A					
V_{RRM}	50 V to 200 V					
I _{FSM}	150 A					
t _{rr}	20 ns					
V _F at I _F	0.95 V					
T _J max.	150 °C					
Package	TO-220AC, ITO-220AC, TO-263AB					
Diode variations	Single die					

FEATURES







· Low switching losses, high efficiency

High forward surge capability

ROHS

- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C (for TO-263AB package)
- Solder dip 275 °C max., 10 s per JESD 22-B106 (for TO-220AC and ITO-220AC package)
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectifier of switching mode power supplies, inverters, freewheeling diodes, DC/DC converters, and other power switching application.

MECHANICAL DATA

Case: TO-220AC, ITO-220AC, TO-263AB

Molding compound meets UL 94V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 gualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

Mounting Torque: 10 in-lbs max.

MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	UG8AT	UG8BT	UG8CT	UG8DT	UNIT	
Max. repetitive peak reverse voltage	V_{RRM}	50	100	150	200	V	
Max. RMS voltage	V _{RMS}	35	70	105	140	V	
Max. DC blocking voltage	V_{DC}	50	100	150	200	V	
Max. average forward rectified current at T _C = 100 °C	I _{F(AV)}	8.0			Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	150			А		
Operating junction and storage temperature range	T_J , T_{STG}	- 55 to + 150				°C	
Isolation voltage (ITO-220AC only) from terminals to heatsink t = 1 min	V _{AC}	1500				V	

UG8xT, UGF8xT, UGB8xT

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ELECTRICAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)									
PARAMETER	TEST CONDIT	TIONS	SYMBOL	UG8AT UG8BT UG8CT UG8DT			UG8DT	UNIT	
Max. instantaneous forward voltage	8.0 A			1.0					
	20.0 A	T _J = 150 °C	V_F ⁽¹⁾	1.2					
	5.0 A								
Max. DC reverse current at rated		T _J = 25 °C	I_		1	0			
DC blocking voltage		T _J = 100 °C	I _R	300				μA	
Max. reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_r$	_r = 0.25 A	t _{rr}	20				ns	
Max. reverse recovery time	$I_F = 8.0 \text{ A}, V_R = 30 \text{ V},$	T _J = 25 °C		30					
	dl/dt = 50 A/µs, I _{rr} = 10 % I _{RM}	T _J = 100 °C t _{rr}	t _{rr}	50				ns	
Max. recovered stored charged	$I_F = 8.0 \text{ A}, V_B = 30 \text{ V},$	T _J = 25 °C	Q _{rr}	20				nC	
	$dI/dt = 50 A/\mu s$ $T_J = 100$			45					
Typical junction capacitance	4.0 V, 1 MHz		CJ	45			•	pF	

Note

 $^{^{(1)}\,}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)							
PARAMETER SYMBOL UG8xT UGF8xT UGB8xT UN							
Typical thermal resistance from junction to case	R ₀ JC (1)	4.0	5.0	4.0	°C/W		

ORDERING INFORMATION (Example)								
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
TO-220AC	UG8DT-E3/45	1.80	45	50/tube	Tube			
ITO-220AC	UGF8DT-E3/45	1.95	45	50/tube	Tube			
TO-263AB	UGB8DT-E3/45	1.33	45	50/tube	Tube			
TO-263AB	UGB8DT-E3/81	1.33	81	800/reel	Tape and reel			
TO-220AC	UG8DTHE3/45 (1)	1.80	45	50/tube	Tube			
ITO-220AC	UGF8DTHE3/45 (1)	1.95	45	50/tube	Tube			
TO-263AB	UGB8DTHE3/45 (1)	1.33	45	50/tube	Tube			
TO-263AB	UGB8DTHE3/81 (1)	1.33	81	800/reel	Tape and reel			

Note

⁽¹⁾ AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

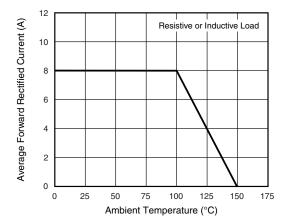


Fig. 1 - Max. Forward Current Derating Curve

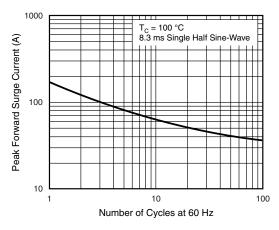


Fig. 2 - Max. Non-Repetitive Peak Forward Surge Current

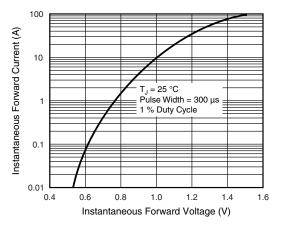


Fig. 3 - Typical Instantaneous Forward Charateristics

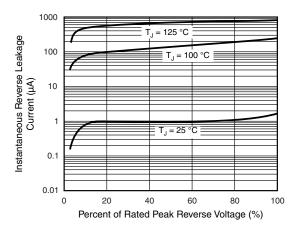


Fig. 4 - Typical Reverse Charateristics

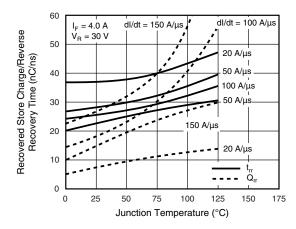


Fig. 5 - Reverse Switching Characteristics

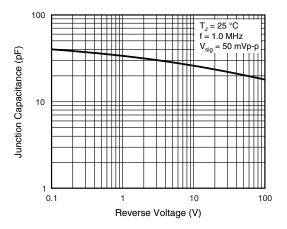
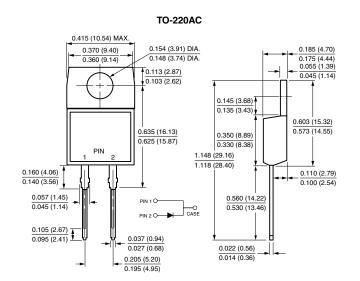


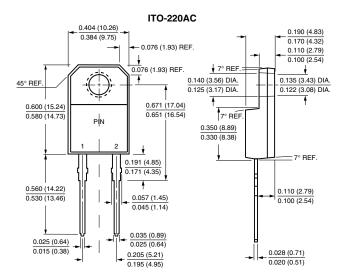
Fig. 6 - Typical Junction Capacitance



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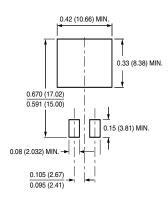
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





TO-263AB 0.411 (10.45) 0.190 (4.83) 0.380 (9.65) 0.160 (4.06) 0.055 (1.40) 0.245 (6.22) 0.045 (1.14) MIN. 0.055 (1.40) 0.360 (9.14) 0.047 (1.19) 0.320 (8.13) 0.624 (15.85) Κ 2 0.591 (15.00) -0 to 0.01 (0 to 0.254) 0.110 (2.79) 0.090 (2.29) 0.037 (0.940) 0.021 (0.53) 0.027 (0.686) 0.014 (0.36) 0.105 (2.67) 0.140 (3.56) 0.095 (2.41) 0.205 (5.20) 0.110 (2.79) 0.195 (4.95)

Mounting Pad Layout





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